

## AA2214VRBXS/A-TR-AMT

2.2 x 1.4 mm Surface Mount LED Lamp



### DESCRIPTIONS

- The source color devices are made with InGaN Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

### FEATURES

- 2.2 mm x 1.4 mm, 1.3 mm high
- Low power consumption
- Available on tape and reel
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

### APPLICATIONS

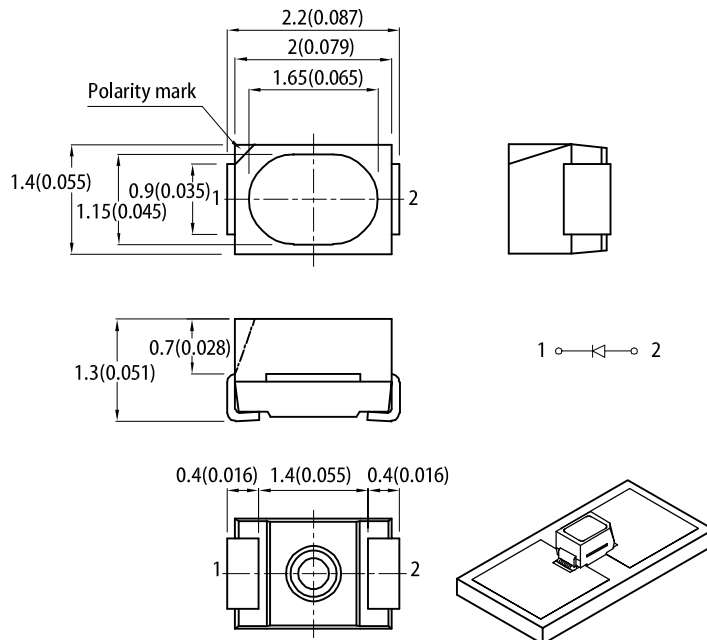
- Traffic signaling
- Backlighting (illuminated advertising , general lighting)
- Interior and exterior automotive lighting
- Substitution of micro incandescent lamps
- Reading lamps
- Signal and symbol luminaire for orientation
- Marker lights (e.g. Steps, exit ways, etc)
- Decorative and entertainment lighting
- Indoor and outdoor commercial and residential architectural lighting

### ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

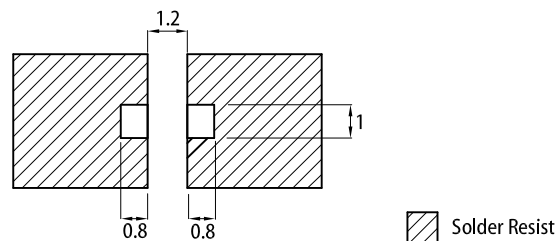


### PACKAGE DIMENSIONS



### RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance :  $\pm 0.1$ )



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.2(0.008)$  unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

### SELECTION GUIDE

| Part Number          | Emitting Color (Material) | Iv (mcd) @ 20mA <sup>[2]</sup> |      |      | Viewing Angle <sup>[1]</sup> |
|----------------------|---------------------------|--------------------------------|------|------|------------------------------|
|                      |                           | Code.                          | Min. | Max. | 2θ1/2                        |
| AA2214VRBXS/A-TR-AMT | Blue (InGaN)              | T                              | 700  | 1000 | 120°                         |
|                      |                           | U                              | 1000 | 1300 |                              |
|                      |                           | V                              | 1300 | 1600 |                              |

#### Notes:

1.  $\theta_{1/2}$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux:  $\pm 15\%$ .
3. Luminous intensity value is traceable to CIE127-2007 standards.

**ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C**

| Parameter                                                                             | Symbol                        | Emitting Color | Value |      | Unit                 |
|---------------------------------------------------------------------------------------|-------------------------------|----------------|-------|------|----------------------|
|                                                                                       |                               |                | Typ.  | Max. |                      |
| Chromaticity Coordinates x<br>I <sub>F</sub> = 20mA                                   | x <sup>[1]</sup>              | Blue           | 0.19  | -    | -                    |
| Chromaticity Coordinates y<br>I <sub>F</sub> = 20mA                                   | y <sup>[1]</sup>              | Blue           | 0.26  | -    | -                    |
| Capacitance                                                                           | C                             | Blue           | 100   | -    | pF                   |
| Forward Voltage I <sub>F</sub> = 20mA                                                 | V <sub>F</sub> <sup>[2]</sup> | Blue           | 3.3   | 4.0  | V                    |
| Reverse Current (V <sub>R</sub> = 5V)                                                 | I <sub>R</sub>                | Blue           | -     | 50   | uA                   |
| Temperature Coefficient of x<br>I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 100°C              | TC <sub>x</sub>               | Blue           | -0.16 | -    | 10 <sup>-3</sup> /°C |
| Temperature Coefficient of y<br>I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 100°C              | TC <sub>y</sub>               | Blue           | -0.18 | -    | 10 <sup>-3</sup> /°C |
| Temperature Coefficient of V <sub>F</sub><br>I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 100°C | TC <sub>V</sub>               | Blue           | -3.0  | -    | mV/°C                |

**Notes:**

1. Measurement tolerance of the chromaticity coordinates is ±0.01.

2. Forward voltage: ±0.1V.

3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

**ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C**

| Parameter                                    | Symbol                            | Value       | Unit |
|----------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation                            | P <sub>D</sub>                    | 120         | mW   |
| Reverse Voltage                              | V <sub>R</sub>                    | 5           | V    |
| Junction Temperature                         | T <sub>j</sub>                    | 115         | °C   |
| Operating Temperature                        | T <sub>op</sub>                   | -40 to +100 | °C   |
| Storage Temperature                          | T <sub>stg</sub>                  | -40 to +110 | °C   |
| DC Forward Current                           | I <sub>F</sub>                    | 30          | mA   |
| Peak Forward Current                         | I <sub>FM</sub> <sup>[1]</sup>    | 100         | mA   |
| Electrostatic Discharge Threshold (HBM)      | -                                 | 250         | V    |
| Thermal Resistance (Junction / Ambient)      | R <sub>th JA</sub> <sup>[2]</sup> | 330         | °C/W |
| Thermal Resistance (Junction / Solder point) | R <sub>th JS</sub> <sup>[2]</sup> | 215         | °C/W |

**Notes:**

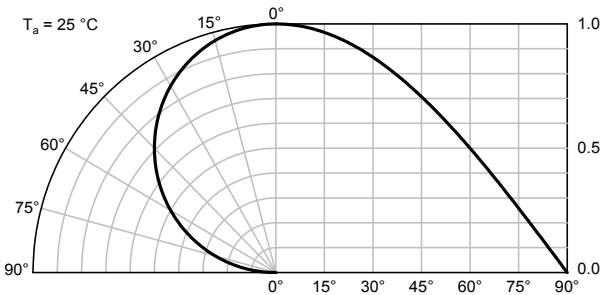
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. R<sub>th JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad).

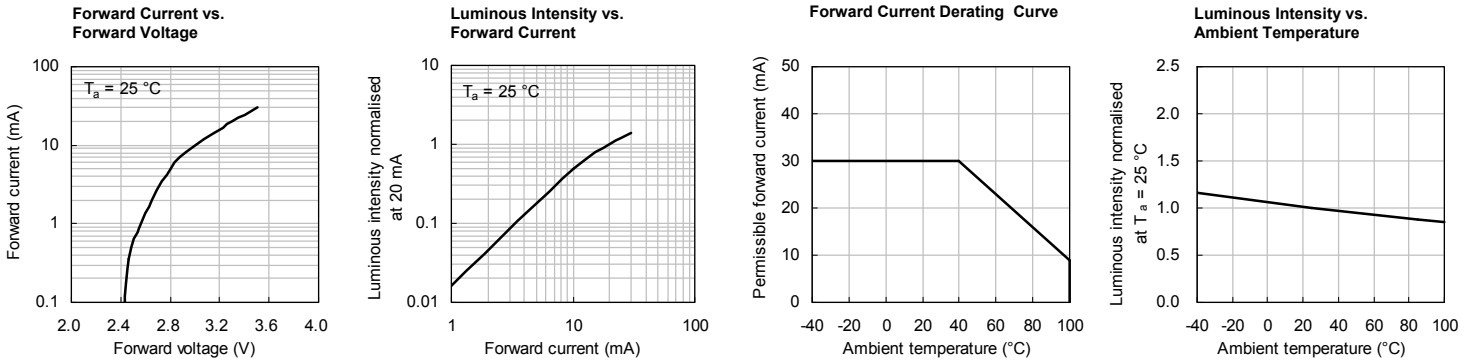
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

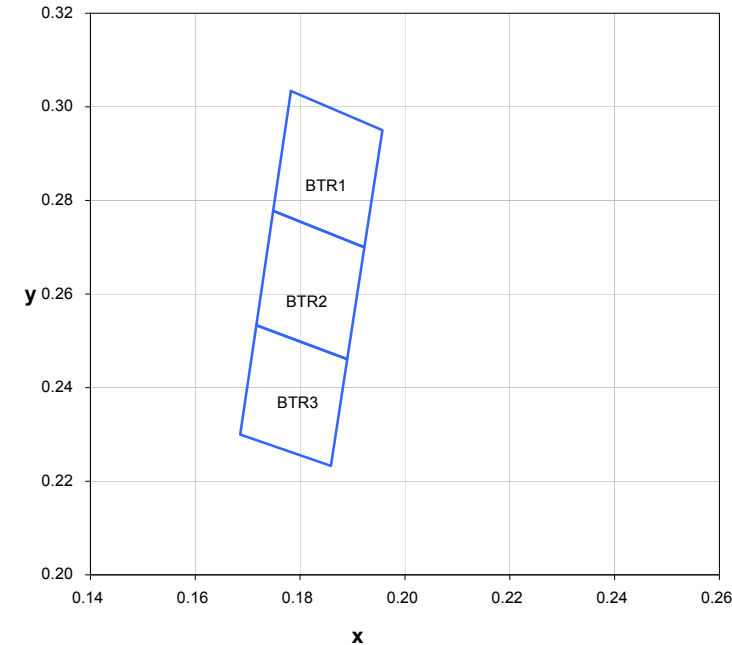
SPATIAL DISTRIBUTION



BLUE



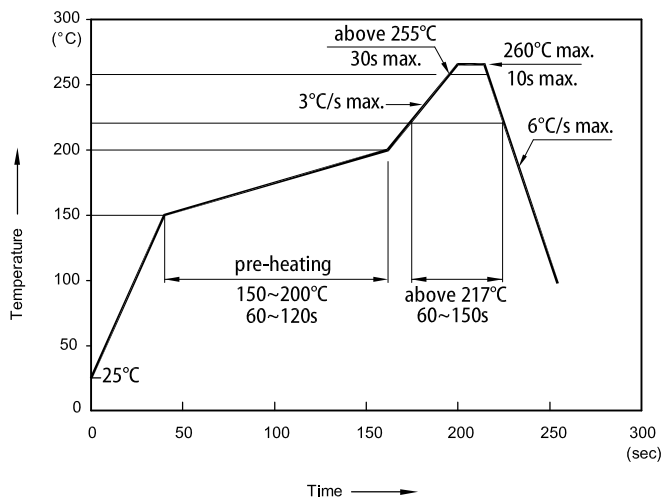
CIE CHROMATICITY DIAGRAM



|      | x      | y      |
|------|--------|--------|
| BTR1 | 0.1782 | 0.3034 |
|      | 0.1749 | 0.2778 |
|      | 0.1923 | 0.2700 |
|      | 0.1957 | 0.2950 |
| BTR2 | 0.1749 | 0.2778 |
|      | 0.1716 | 0.2533 |
|      | 0.1890 | 0.2461 |
|      | 0.1923 | 0.2700 |
| BTR3 | 0.1716 | 0.2533 |
|      | 0.1686 | 0.2300 |
|      | 0.1859 | 0.2233 |
|      | 0.1890 | 0.2461 |

Notes:  
Shipment may contain more than one chromaticity regions.  
Orders for single chromaticity region are generally not accepted.  
Measurement tolerance of the chromaticity coordinates is  $\pm 0.01$ .

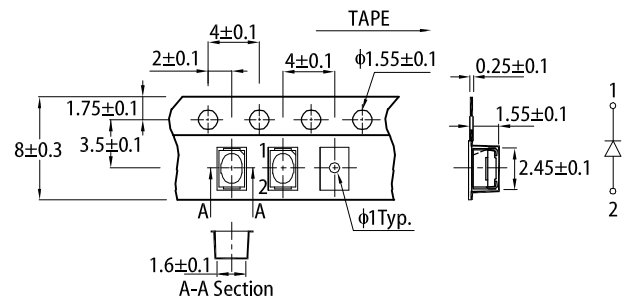
## REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



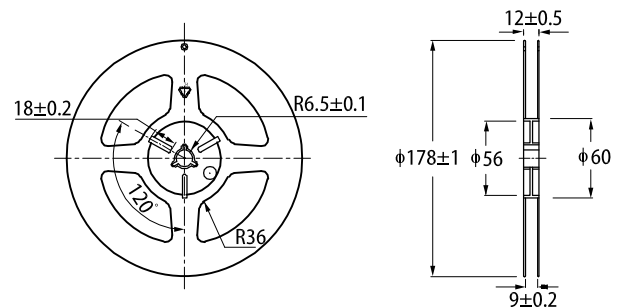
Notes:

1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

## TAPE SPECIFICATIONS (units : mm)



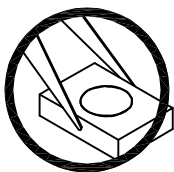
## REEL DIMENSION (units : mm)



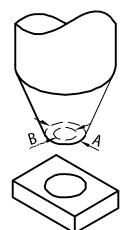
## HANDLING PRECAUTIONS

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.
2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.
5. As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.



**RELIABILITY TEST ITEMS AND CONDITIONS**

The reliability of products shall be satisfied with items listed below

**LOT TOLERANCE PERCENT DEFECTIVE (LTPD) : 10%**

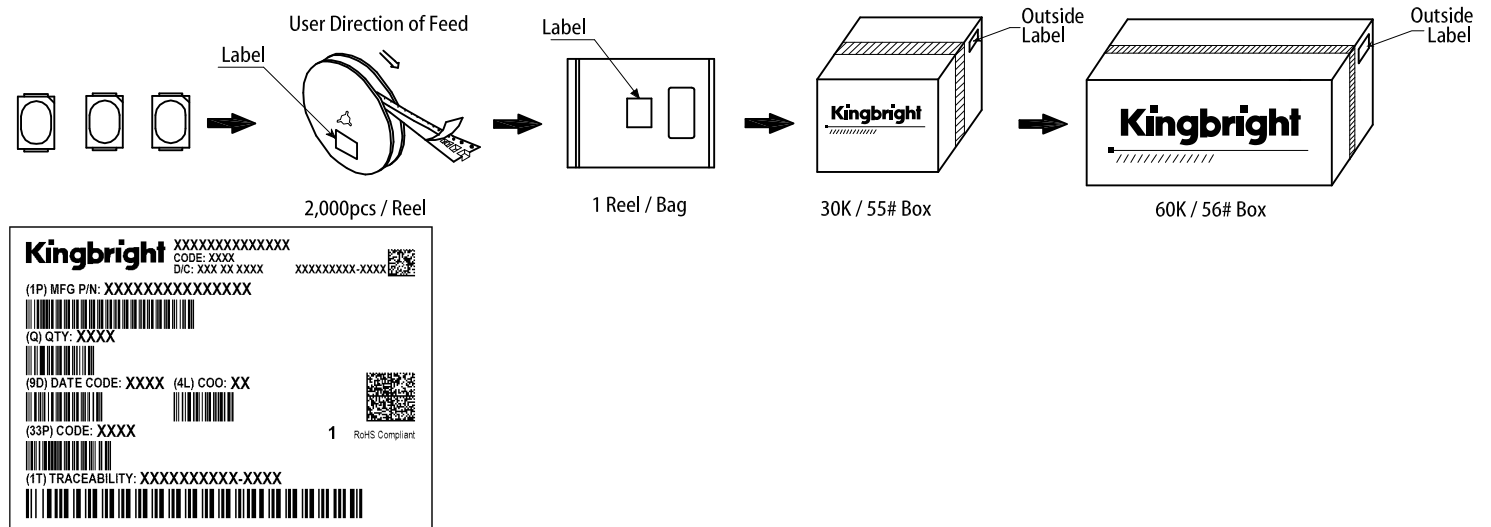
| No. | Test Item                            | Standards             | Test Condition                                                                                                                                         | Test Times / Cycles | Number of Damaged |
|-----|--------------------------------------|-----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|-------------------|
| 1   | Continuous operating test            | -                     | $T_a = 25^{\circ}\text{C}$ , $I_F = \text{maximum rated current} *$                                                                                    | 1,000 h             | 0 / 22            |
| 2   | High Temp. operating test            | EIAJ ED-4701/100(101) | $T_a = 100^{\circ}\text{C}$ , $I_F = \text{derated current at } 100^{\circ}\text{C}$                                                                   | 1,000 h             | 0 / 22            |
| 3   | Low Temp. operating test             | -                     | $T_a = -40^{\circ}\text{C}$ , $I_F = \text{maximum rated current} *$                                                                                   | 1,000 h             | 0 / 22            |
| 4   | High temp. storage test              | EIAJ ED-4701/100(201) | $T_a = \text{maximum rated storage temperature}$                                                                                                       | 1,000 h             | 0 / 22            |
| 5   | Low temp. storage test               | EIAJ ED-4701/100(202) | $T_a = -40^{\circ}\text{C}$                                                                                                                            | 1,000 h             | 0 / 22            |
| 6   | High temp. & humidity storage test   | -                     | $T_a = 60^{\circ}\text{C}$ , RH = 90%                                                                                                                  | 500 h               | 0 / 22            |
| 7   | High temp. & humidity operating test | -                     | $T_a = 60^{\circ}\text{C}$ , RH = 90% $I_F = \text{derated current at } 60^{\circ}\text{C}$                                                            | 500 h               | 0 / 22            |
| 8   | Soldering reliability test           | EIAJ ED-4701/100(301) | Moisture soak: $30^{\circ}\text{C}$ , 70% RH, 72h<br>Preheat: $150\sim 180^{\circ}\text{C}$ (120s max.)<br>Soldering temp: $260^{\circ}\text{C}$ (10s) | 2 times             | 0 / 18            |
| 9   | Thermal shock operating test         | -                     | $T_a = -40^{\circ}\text{C}(15\text{min}) \sim 100^{\circ}\text{C}(15\text{min})$<br>$I_F = \text{derated current at } 100^{\circ}\text{C}$             | 1,000 cycles        | 0 / 22            |
| 10  | Thermal shock test                   | -                     | $T_a = -40^{\circ}\text{C}(15\text{min}) \sim 100^{\circ}\text{C}(15\text{min})$                                                                       | 1,000 cycles        | 0 / 22            |
| 11  | Electric Static Discharge (ESD)      | EIAJ ED-4701/100(304) | C = 100pF, R2 = 1.5K $\Omega$ V = 250V                                                                                                                 | Once each Polarity  | 0 / 22            |
| 12  | Vibration test                       | -                     | a = 196m/s <sup>2</sup> , f = 100~2KHz, t = 48min for all xyz axes                                                                                     | 4 times             | 0 / 22            |

\* : Refer to forward current vs. derating curve diagram

**CRITERIA FOR JUDGING DAMAGE**

| Items                   | Symbols | Conditions                                   | Failure Criteria                                             |
|-------------------------|---------|----------------------------------------------|--------------------------------------------------------------|
| luminous Intensity      | $I_V$   | $I_F = 20\text{mA}$                          | Testing Min. Value < Spec. Min. Value x 0.5                  |
| Forward Voltage         | $V_F$   | $I_F = 20\text{mA}$                          | Testing Max. Value $\geq$ Spec. Max. Value x 1.2             |
| Reverse Current         | $I_R$   | $V_R = \text{Maximum Rated Reverse Voltage}$ | Testing Max. Value $\geq$ Spec. Max. Value x 2.5             |
| High temp. storage test | -       | -                                            | Occurrence of notable decoloration, deformation and cracking |

## PACKING & LABEL SPECIFICATIONS



## PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
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